

## 1.5A, 1000V Fast avalanche Surface Mount Rectifier

#### **FEATURES**

- Glass passivated junction chip
- Ideal for automated placement
- Fast switching for high efficiency
- High surge current capability
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21



**DO-214AC (SMA)** 





#### **TYPICAL APPLICATION**

The superior avalanche capability of BYG21M is specially suited for free-wheeling, clamping, snubber, demagnetization in power supplies and other power switching applications.

#### **MECHANICAL DATA**

Case: DO-214AC (SMA)

Molding compound: UL flammability classification rating 94V-0 Moisture sensitivity level (MSL): level 1, per J-STD-020 Part no. with suffix "H" means AEC-Q101 qualified

Packing code with suffix "G" means green compound (halogen-free) **Terminal:** Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 2 whisker test **Polarity:** Indicated by cathode band **Weight:** 64 mg (approximately)

PARAMETER	SYMBOL	BYG21M	UNIT	
Maximum repetitive peak reverse voltage	$V_{RRM}$	1000	V	
Maximum RMS voltage	$V_{RMS}$	700	V	
Maximum DC blocking voltage	V <sub>DC</sub>	1000		
Maximum average forward rectified current	I <sub>F(AV)</sub>	1.5	А	
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	50	А	
Maximum instantaneous forward voltage $I_F$ =1A (Note 1) $I_F$ =1.5A	V <sub>F</sub>	1.5 1.6	V	
$T_J$ =25°C  Maximum reverse current @ Rated $V_R$ $T_J$ =125°C $T_J$ =125°C	I <sub>R</sub>	1 10 50	μА	
Pulse energy in avalanche mode, non repetitive (Inductive load switch off ) T <sub>A</sub> =25°C, I <sub>(BR)R</sub> =1.23A	E <sub>RSM</sub>	30	mJ	
Maximum reverse recovery time (Note 2)	t <sub>rr</sub>	120	ns	
Typical junction capacitance (Note 3)	CJ	13	pF	
Typical thermal resistance	$R_{ heta JA}$	20 70	°C/W	
Operating junction temperature range	T <sub>.l</sub>	- 55 to +150	°C	
Storage temperature range	T <sub>STG</sub>	- 55 to +150	°C	

Note 1: Pulse test with PW=300 $\mu$ s, 1% duty cycle Note 2: Test conditions:  $I_F$ =0.5A,  $I_R$ =1.0A,  $I_{RR}$ =0.25A

Note 3: Measured at 1 MHz and applied reverse voltage of 4.0V





ORDERING INFORMATION					
PART NO.	PART NO.	PACKING	PACKING CODE	PACKAGE	PACKING
PARTINO.	SUFFIX	CODE	SUFFIX		
BYG21M (Note 1)	R3		SMA	1,800 / 7" Plastic reel	
		R2		SMA	7,500 / 13" Paper reel
	M2	G	SMA	7,500 / 13" Plastic reel	
	F3		Folded SMA	1,800 / 7" Plastic reel	
		F2		Folded SMA	7,500 / 13" Paper reel
		F4		Folded SMA	7,500 / 13" Plastic reel

Note 1: Whole series with green compound

EXAMPLE					
EXAMPLE PART NO.	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
BYG21MHR3G	BYG21M	Ħ	R3	G	AEC-Q101 qualified Green compound

### **RATINGS AND CHARACTERISTICS CURVES**

(T<sub>A</sub>=25°C unless otherwise noted)

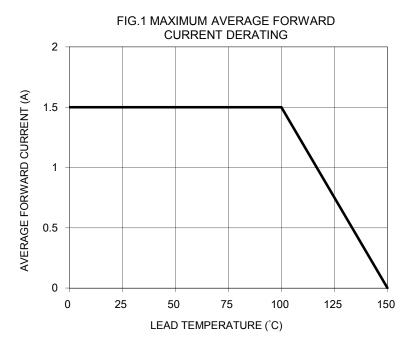


FIG. 2 TYPICAL REVERSE CHARACTERISTICS 100 INSTANTANEOUS REVERSE CURRENT(µA)  $T_J=125^{\circ}C$ 10 1 0.1  $T_J=25^{\circ}C$ 0.01 0 20 100 40 60 80 PERCENT OF RATED PEAK REVERSE VOLTAGE (%)

FIG. 3 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

50

40

8.3ms single half sine wave

10

10

NUMBER OF CYCLES AT 60 Hz

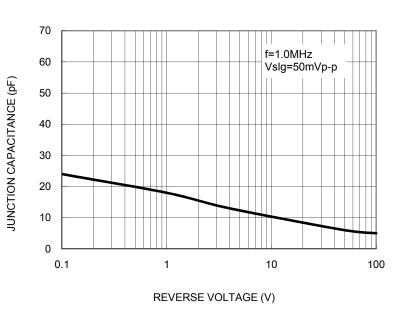
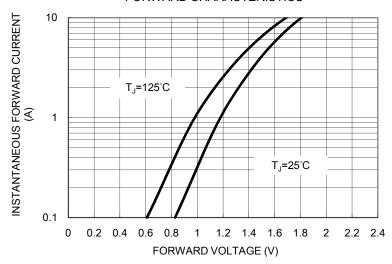


FIG. 4 TYPICAL JUNCTION CAPACITANCE

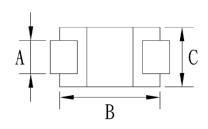
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FIG. 5 TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS



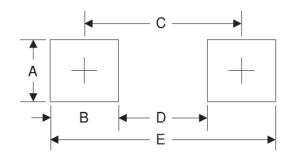
# PACKAGE OUTLINE DIMENSIONS DO-214AC (SMA)



Н	
	-
D	
EGA	
F	

DIM.	Unit (mm)		Unit (inch)	
Dilvi.	Min	Max	Min	Max
Α	1.27	1.58	0.050	0.062
В	4.06	4.60	0.160	0.181
С	2.29	2.83	0.090	0.111
D	1.99	2.50	0.078	0.098
Е	0.90	1.41	0.035	0.056
F	4.95	5.33	0.195	0.210
G	0.10	0.20	0.004	0.008
Н	0.15	0.31	0.006	0.012

## **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
А	1.68	0.066
В	1.52	0.060
С	3.93	0.155
D	2.41	0.095
E	5.45	0.215

### **MARKING DIAGRAM**



P/N = Specific Device Code G = Green Compound

YW = Date Code F = Factory Code







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